DECLARATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled APPARATUS AND METHOD FOR FORMING A MOLDING TRIM, the application for which

(check one)	[X]	is attached hereto	
	[]	was filed on	as Application Serial No
			n (if applicable).
			ed and understand the contents of the above identified ended by any amendment referred to above.
	_	-	e information which is material to the examination of 7, Code of Federal Regulations, § 1.56(a).
foreign application below any for	cation(s) reign ap	for patent or inver	nefits under Title 35, United States Code, § 119 of any ator's certificate listed below and have also identified or inventor's certificate having a filing date before that med.
all statements statements we punishable by	s made ere made or fine or well well.	on information and with the knowledg imprisonment, or bo	s made herein of my own knowledge are true and that belief are believed to be true; and further that these e that willful false statements and the like so made are oth, under Section 1001 of Title 18 of the United States is may jeopardize the validity of the application or any
described and	claimed	l in the foregoing spe	tent be granted to me for the invention or discovery ecification and claims, and I hereby subscribe my name declaration, power of attorney, and this petition.
Full name of	sole or	first,inventor Jim	Thiessen
Inventor's sig		Fin 1 =-	
Date Dec	118/0	1	
		BODEFFER	PL. SAVGUS CA 9/350
Citizenship			•
Post Office A	ddress	Same	

Matter No.: 370023/79

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Commissioner of Patents Washington, D.C. 20231

POWER OF ATTORNEY

Sir:

GRUBER SYSTEMS, INC. having become the owner of all rights to this application by virtue of an Assignment executed by the inventor concurrently with the execution of the application, the Assignment being submitted with this power of attorney for recording, appoints:

Alumit, John ¹	Ellisen, E. Patrick ¹ Farber, Michael ¹	Inskeep, James ¹	Rose, Alan ¹
Berman, Charles ¹		Jastram, Harold ³	Rosenberg, Charles ¹
Bosworth, Michael	Grahn, Barbara ³	Khang, Joon ¹	Schatz, James ³
	Hansen, Scott ¹	Koster, Erica ³	Smith, Guy Porter ¹
Bovasso, Louis¹ Brown, Marc¹	Harris, Michael ¹	Lervick, Craig ³	Tenen-Aoki, Elise ^t
Choderker, Dorie	Hickman, Paul ¹	Lieske, Steven ³	Triber, Gregory ¹
Choppelas, Alison ¹ Darrow, Christopher ¹	Hourizadeh, Ellie ¹	Pontaoe, Sheldon ⁴	Tyler, Kathryn ¹
	Hughes, Michael ¹	Roberts, Raymond ¹	Vicinanza, Joseph ⁴

all admitted as attorneys at law in one of the following states indicated by the number following his or her name (1) California, (2) District of Columbia, (3) Minnesota and (4) New York. Their address is listed below as the address for OPPENHEIMER WOLFF & DONNELLY LLP:

OPPENHEIMER WOLFF & DONNELLY LLP

2029 Century Park East, 38th Floor Los Angeles, California 90067 Telephone (310) 788-5000 Fax (310) 788-5100

Attn: Louis J. Bovasso, Esq. Direct Telephone: (310) 788-5035

as their attorneys to prosecute this application and to transact in connection with the application all business in the Patent and Trademark Office and before competent International Authorities including the World Intellectual Property Organization.

To the best of my knowledge and belief, title is in the assignee identified above. I am empowered to act on behalf of the assignee.

I declare that all statements made in this document of my own knowledge are true, and that all statements made on information and belief are believed to be true. I make these state-

ments with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing from the application.

GRUBER SYSTEMS, INC.

Date: 12/18/01

Title:_